

MDTA Series

Flat Wire Molded Inductor

Size 7070



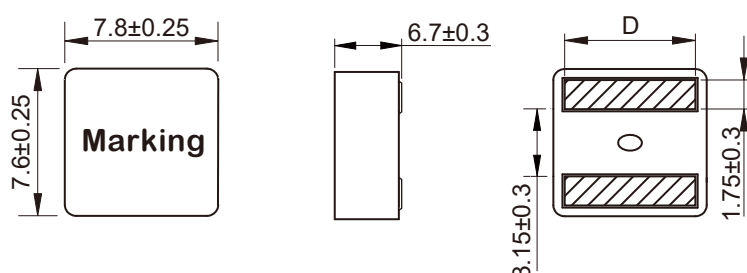
FEATURES

- Flat wire coil for low copper losses
- Composite core material allows high saturation currents
- Very low acoustic noise and very low leakage flux noise
- High current capability and handles high transient current spikes
- AEC-Q200 qualified
- Operating temperature -55 to +155 °C (Including self - temperature rise)
- Quantity: 700pcs

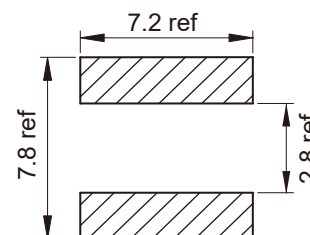
APPLICATION

- DC/DC converters for entertainment/navigation systems
- Noise suppression for motors: windshield wipers / power seats / power mirrors / heating and ventilation blowers / HID lighting
- LED drivers

Dimensions: [mm]



Land Pattern: [mm]



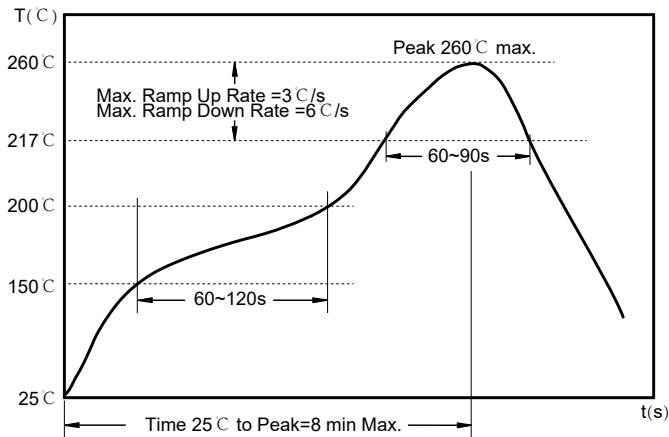
Electrical Properties:

Part No	L@100KHz /0.1V (μH)	Tolerance	I _{SAT} Typ. (A)	I _r (A)		R _{DC} Max. (mΩ)	D (mm)
				20°C rise	40°C rise		
MDTA7070-1R0M	1.00	±20%	34.8	20.0	25.0	2.81	6.7±0.3
MDTA7070-1R8M	1.80	±20%	25.0	15.8	21.0	4.46	6.7±0.3
MDTA7070-3R3M	3.30	±20%	19.4	11.5	15.1	9.42	6.7±0.3
MDTA7070-4R7M	4.70	±20%	15.5	10.5	13.6	13.5	6.7±0.3
MDTA7070-6R8M	6.80	±20%	12.8	7.0	9.5	19.6	6.5±0.3

Saturation Current will cause L to drop approximately 30%

Temperature Rise Current that causes the specified temperature rise from 25°C ambient.

Soldering Reflow:



Preheat condition: 150 ~200°C / 60~120 sec.

Allowed time above 217°C: 60~90 sec.

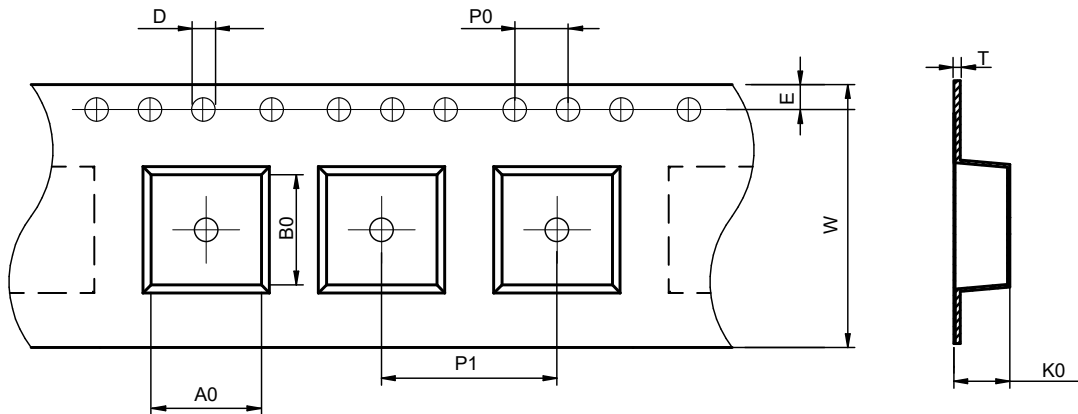
Max temperature: 260°C.

Max time at max temperature: 10 sec.

Allowed Reflow time: 2x max.

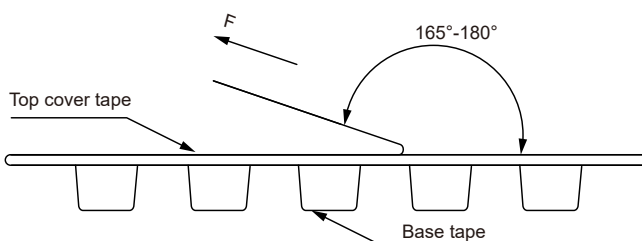
Packaging Information:

Tape Dimension:



Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
MDTA7070	8.2±0.1	8.0±0.1	1.5±0.1	4.0±0.1	12.0±0.1	16.0±0.3	7.3±0.1	1.75±0.1	0.50±0.05

Peel force of top cover tape:

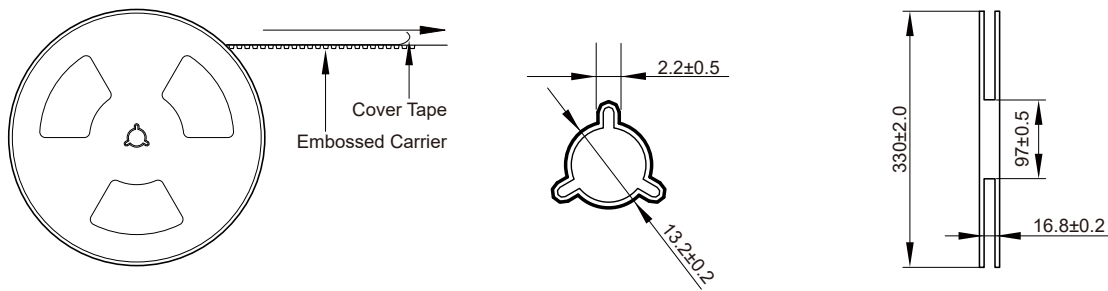


The peel force of top cover tape shall be between 0.1 to 1.3 N

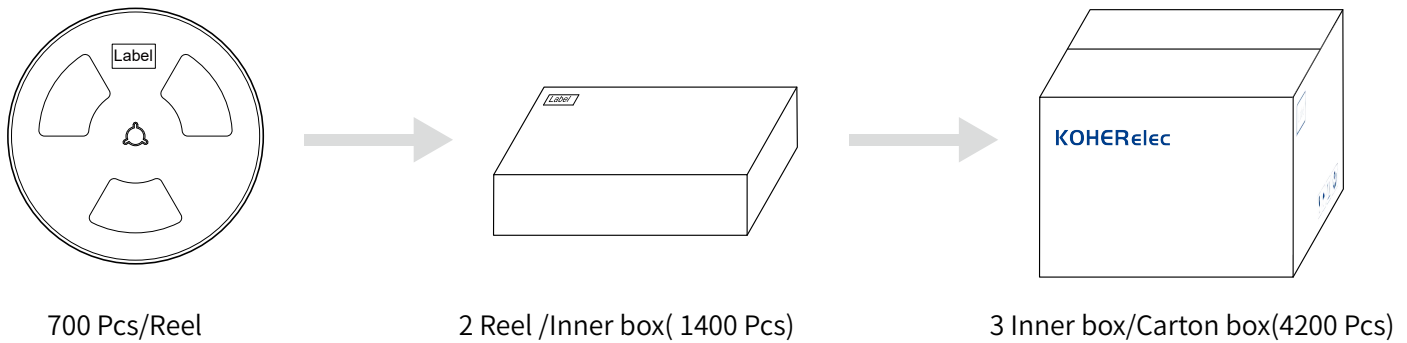
Product Marking:

Marking	Printing (Inductance)
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Reel Dimension: [mm]



Packaging Quantity:



Cautions and Warnings:

Storage Conditions:

- The storage period is within 12 months after the completion of production. Be sure to follow the storage conditions (temperature: -5 to 35°C, humidity: 75% RH Max). If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
- Product should not be exposed to environment with high temperature, high humidity, dust, corrosive gas and etc.
- Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- Please always handle products carefully to prevent any damage caused by dropping down or inappropriate removing.

Operation Instructions:

- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- Generally, Koher might not be familiar with either customer's specific application or actual requests as customer does. As a result customer shall be responsible for checking and confirming whether Koher product with the performance described in the product specification is suitable for using in customer's particular application or not.